Panasonic INDUSTRY

Aluminum Electrolytic Capacitors

Surface Mount Type

FT series

High temperature Lead-Free reflow

Features

- Endurance : 105 ℃ 2000 h to 5000 h
- Miniaturized, Low ESR (1 size smaller than series FK)
- AEC-Q200 compliant
- RoHS compliant

Specifications

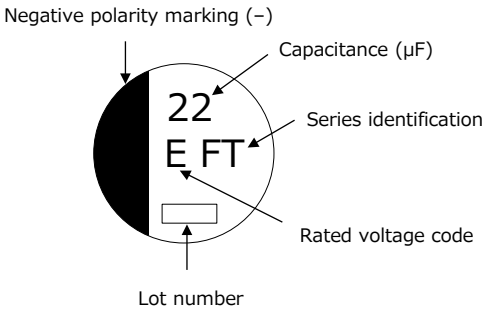
Category temp. range	−55 ℃ to +105 ℃	
Rated voltage range	6.3 V to 50 V	
Capacitance range	10 μF to 2200 μF	
Capacitance tolerance	±20 % (120 Hz / +20 ℃)	
Leakage current	I ≦ 0.01 CV (μA) After 2 minutes	
Dissipation factor (tan δ)	Please see the attached characteristics list	
Endurance	After applying rated working voltage for 2000 hours at +105 ℃ ± 2 ℃ and then being stabilized at +20 ℃, capacitors shall meet the following limits. (Suffix "G" in 6.3 V : 3000 hours, 10 V to 50 V : 5000 hours)	
	Capacitance change	Within ±30 % of the initial value (Suffix "G" is ±35 %)
	Dissipation factor (tan δ)	≦ 200 % of the initial limit (Suffix "G" is ≦ 300 %)
	Leakage current	Within the initial limit
Shelf life	After storage for 1000 hours at +105 ℃ ± 2 ℃ with no voltage applied and then being stabilized at +20 ℃, capacitors shall meet the limits specified in endurance. (With voltage treatment)	
Resistance to soldering heat	After reflow soldering and then being stabilized at +20 ℃, capacitors shall meet the following limits.	
	Capacitance change	Within ±10 % of the initial value
	Dissipation factor (tan δ)	Within the initial limit
	Leakage current	Within the initial limit

Frequency correction factor for ripple current

Cap. (μF) \ Freq. (Hz)	120	1 k	10 k	100 k to
10 to 470	0.65	0.85	0.95	1.00
560 to 2200	0.70	0.90	0.95	1.00

Marking

Example : 25 V 22 μF
Marking color : BLACK

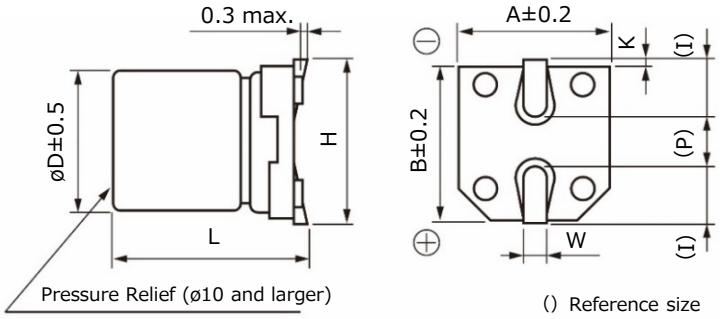


R.voltage code

j	6.3	E	25
A	10	V	35
C	16	H	50

Unit : V

Dimensions



Unit : mm

Size code	øD	L	A、B	H	I	W	P	K
B	4.0	5.8±0.3	4.3	5.5 max.	1.8	0.65±0.1	1.0	$0.35^{+0.15}_{-0.20}$
C	5.0	5.8±0.3	5.3	6.5 max.	2.2	0.65±0.1	1.5	$0.35^{+0.15}_{-0.20}$
D	6.3	5.8±0.3	6.6	7.8 max.	2.6	0.65±0.1	1.8	$0.35^{+0.15}_{-0.20}$
D8	6.3	7.7±0.3	6.6	7.8 max.	2.6	0.65±0.1	1.8	$0.35^{+0.15}_{-0.20}$
F	8.0	10.2±0.3	8.3	10.0 max.	3.4	0.90±0.2	3.1	0.70±0.2
G	10.0	10.2±0.3	10.3	12.0 max.	3.5	0.90±0.2	4.6	0.70±0.2

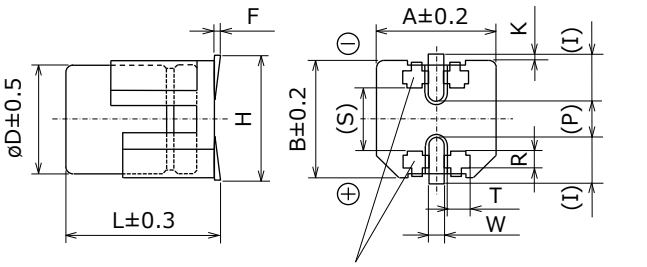
・The dimensions of the vibration-proof products, please refer to the page of the mounting specification.

Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use.
Should a safety concern arise regarding this product, please be sure to contact us immediately.

Dimensions (Vibration-proof products)

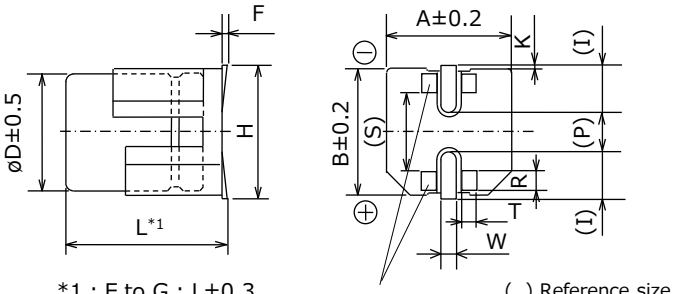
✻ The size and shape are different from standard products. Please inquire details of our company.

< Size code : D, D8 >



Supportive Terminals ( ) Reference size

< Size code : E, F, G, H13, J16, K16, K21 >



*1 : E to G : L±0.3
H13 to K21 : L±0.5

Supportive Terminals ( ) Reference size

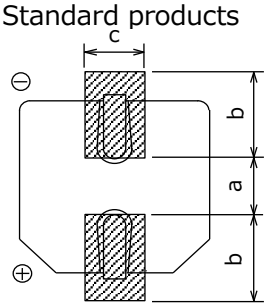
Unit : mm

Size code	øD	L	A, B	H max.	F	I	W	P	K	R	S	T
D	6.3	6.1	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 $^{+0.15}_{-0.20}$	1.1±0.2	3.3	1.05±0.2
D8	6.3	8.0	6.6	7.8	0 to +0.15	2.4	0.65±0.1	2.2	0.35 $^{+0.15}_{-0.20}$	1.1±0.2	3.3	1.05±0.2
E	8.0	6.5	8.3	9.5	0 to +0.15	3.4	0.7±0.1	2.2	0.35 $^{+0.15}_{-0.20}$	0.70±0.2	5.3	1.7±0.2
F	8.0	10.5	8.3	10.0	0 to +0.15	3.4	1.2±0.2	3.1	0.70±0.2	0.70±0.2	5.3	1.3±0.2
G	10.0	10.5	10.3	12.0	0 to +0.15	3.5	1.2±0.2	4.6	0.70±0.2	0.70±0.2	6.9	1.3±0.2
H13	12.5	13.8	13.5	15.0	−0.1 to +0.15	4.7	1.2±0.2	4.4	0.70±0.3	2.2±0.2	7.1	2.4±0.2
J16	16.0	16.8	17.0	19.0	−0.1 to +0.15	5.5	1.4±0.2	6.7	0.70±0.3	3.0±0.2	9.0	1.9±0.2
K16	18.0	16.8	19.0	21.0	−0.1 to +0.15	6.7	1.4±0.2	6.7	0.70±0.3	3.0±0.2	11.0	1.9±0.2
K21	18.0	21.8	19.0	21.0	−0.1 to +0.15	6.7	1.4±0.2	6.7	0.70±0.3	3.0±0.2	11.0	1.9±0.2

Land / Pad pattern

The circuit board land/pad pattern size for chip capacitors is specified in the following table.
The land pitch influences installation strength and consider it.

● Standard products



Land space

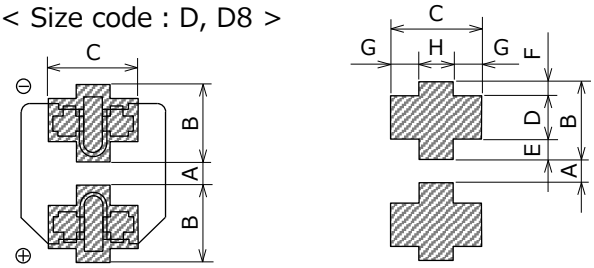
(Table of board land size vs. capacitor size) Unit : mm

Size code	a	b	c
B (ø4)	1.0	2.5	1.6
C (ø5)	1.5	2.8	1.6
D (ø6.3)	1.8	3.2	1.6
D8 (ø6.3x7.7L)	1.8	3.2	1.6
E (ø8x6.2L)	2.2	4.0	1.6
F (ø8x10.2L)	3.1	4.0	2.0
G (ø10x10.2L)	4.6	4.1	2.0
H (ø12.5)	4.0	5.7	2.0
J (ø16)	6.0	6.5	2.5
K (ø18)	6.0	7.5	2.5

When size "a" is wide, back fi llet can be made, decreasing fi tting strength.

● Vibration-proof products

< Size code : D, D8 >

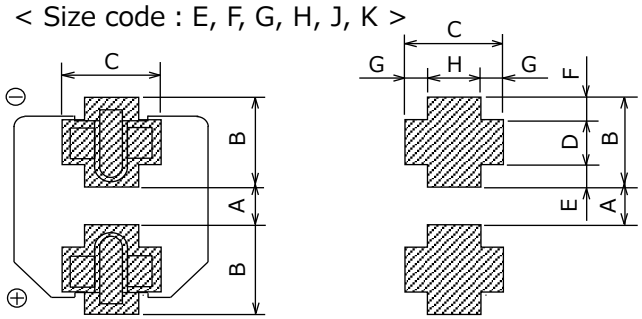


(Table of board land size vs. capacitor size) Unit : mm

Size code	A	B	C	D	E	F	G	H
D (ø6.3xL6.1)	1.2	3.6	3.2	2.0	0.95	0.65	1.0	1.2
D8 (ø6.3xL8.0)	1.2	3.6	3.2	2.0	0.95	0.65	1.0	1.2
E (ø8x6.5L)	1.8	4.2	5.0	1.3	1.5	1.4	1.5	2.0
F (ø8x10.5L)	2.7	4.0	4.7	1.3	1.0	1.7	1.1	2.5
G (ø10)	3.9	4.4	4.7	1.3	1.2	1.9	1.1	2.5
H (ø12.5)	3.9	6.0	6.9	2.8	1.3	1.9	2.2	2.5
J (ø16)	5.8	6.8	6.2	3.6	1.3	1.9	1.7	2.8
K (ø18)	5.8	7.3	6.2	3.6	1.8	1.9	1.7	2.8

When size "A" is wide, back fi llet can be made, decreasing fi tting strength.

< Size code : E, F, G, H, J, K >



∗Take mounting conditions, solderability and fi tting strength into consideration when selecting parts for your company's design.

∗ The vibration-proof capacitors of size ø6.3 has support terminals extending from the bottom side to the lead edge. Then, make sure to find appropriate soldering conditions to form fillet on the support terminals if required for appearance inspection.

Characteristics list

Endurance : 105 ℃ 2000 h

Rated voltage (V)	Capacitance (±20 %) (μF)	Case size (mm) φD	Case size (mm) L Standard	Case size (mm) L Vibration-proof	Size code*1	Specification Ripple current*2 (mA rms)	Specification ESR*3 (Ω)	Specification tan δ*4	Part No. Standard Product	Part No. Vibration-proof product	Reflow	Min. Packaging Q'ty (pcs) Taping
6.3	100	4.0	5.8	–	B	160	0.85	0.26	EEEFT0J101AR	–	(5)	2000
	220	5.0	5.8	–	C	240	0.36	0.26	EEEFT0J221AR	–	(5)	1000
	330	6.3	5.8	6.1	D	300	0.26	0.26	EEEFT0J331AP	EEEFT0J331AV	(5)	1000
	470	6.3	7.7	8.0	D8	600	0.16	0.26	EEEFTJ471XAP	EEEFTJ471XAV	(5)	900
	680	6.3	7.7	8.0	D8	600	0.16	0.26	EEEFTJ681XAP	EEEFTJ681XAV	(5)	900
	1500	8.0	10.2	10.5	F	850	0.08	0.26	EEEFT0J152AP	EEEFT0J152AV	(6)	500
	2200	10.0	10.2	10.5	G	1190	0.06	0.28	EEEFT0J222AP	EEEFT0J222AV	(6)	500
10	68	4.0	5.8	–	B	160	0.85	0.19	EEEFT1A680AR	–	(5)	2000
	150	5.0	5.8	–	C	240	0.36	0.19	EEEFT1A151AR	–	(5)	1000
	220	6.3	5.8	6.1	D	300	0.26	0.19	EEEFT1A221AP	EEEFT1A221AV	(5)	1000
	330	6.3	7.7	8.0	D8	600	0.16	0.19	EEEFTA331XAP	EEEFTA331XAV	(5)	900
	470	6.3	7.7	8.0	D8	600	0.16	0.19	EEEFTA471XAP	EEEFTA471XAV	(5)	900
	1000	8.0	10.2	10.5	F	850	0.08	0.19	EEEFT1A102AP	EEEFT1A102AV	(6)	500
	1500	10.0	10.2	10.5	G	1190	0.06	0.19	EEEFT1A152AP	EEEFT1A152AV	(6)	500
16	47	4.0	5.8	–	B	160	0.85	0.16	EEEFT1C470AR	–	(5)	2000
	68	5.0	5.8	–	C	240	0.36	0.16	EEEFT1C680AR	–	(5)	1000
	100	5.0	5.8	–	C	240	0.36	0.16	EEEFT1C101AR	–	(5)	1000
	150	6.3	5.8	6.1	D	300	0.26	0.16	EEEFT1C151AP	EEEFT1C151AV	(5)	1000
	220	6.3	5.8	6.1	D	300	0.26	0.16	EEEFT1C221AP	EEEFT1C221AV	(5)	1000
	330	6.3	7.7	8.0	D8	600	0.16	0.16	EEEFTC331XAP	EEEFTC331XAV	(5)	900
	680	8.0	10.2	10.5	F	850	0.08	0.16	EEEFT1C681AP	EEEFT1C681AV	(6)	500
	820	8.0	10.2	10.5	F	850	0.08	0.16	EEEFT1C821UP	EEEFT1C821UV	(6)	500
	1000	10.0	10.2	10.5	G	1190	0.06	0.16	EEEFT1C102AP	EEEFT1C102AV	(6)	500
	1200	10.0	10.2	10.5	G	1190	0.06	0.16	EEEFT1C122UP	EEEFT1C122UV	(6)	500
25	22	4.0	5.8	–	B	160	0.85	0.14	EEEFT1E220AR	–	(5)	2000
	33	4.0	5.8	–	B	160	0.85	0.14	EEEFT1E330AR	–	(5)	2000
	47	5.0	5.8	–	C	240	0.36	0.14	EEEFT1E470AR	–	(5)	1000
	68	5.0	5.8	–	C	240	0.36	0.14	EEEFT1E680AR	–	(5)	1000
	100	6.3	5.8	6.1	D	300	0.26	0.14	EEEFT1E101AP	EEEFT1E101AV	(5)	1000
	150	6.3	7.7	8.0	D8	600	0.16	0.14	EEEFTE151XAP	EEEFTE151XAV	(5)	900
	220	6.3	7.7	8.0	D8	600	0.16	0.14	EEEFTE221XAP	EEEFTE221XAV	(5)	900
	470	8.0	10.2	10.5	F	850	0.08	0.14	EEEFT1E471AP	EEEFT1E471AV	(6)	500
	560	8.0	10.2	10.5	F	850	0.08	0.14	EEEFT1E561UP	EEEFT1E561UV	(6)	500
	820	10.0	10.2	10.5	G	1190	0.06	0.14	EEEFT1E821AP	EEEFT1E821AV	(6)	500
	1000	10.0	10.2	10.5	G	1190	0.06	0.14	EEEFT1E102UP	EEEFT1E102UV	(6)	500
35	22	4.0	5.8	–	B	160	0.85	0.12	EEEFT1V220AR	–	(5)	2000
	33	5.0	5.8	–	C	240	0.36	0.12	EEEFT1V330AR	–	(5)	1000
	47	5.0	5.8	–	C	240	0.36	0.12	EEEFT1V470AR	–	(5)	1000
	68	6.3	5.8	6.1	D	300	0.26	0.12	EEEFT1V680AP	EEEFT1V680AV	(5)	1000
	100	6.3	5.8	6.1	D	300	0.26	0.12	EEEFT1V101AP	EEEFT1V101AV	(5)	1000
	150	6.3	7.7	8.0	D8	600	0.16	0.12	EEEFTV151XAP	EEEFTV151XAV	(5)	900
	330	8.0	10.2	10.5	F	850	0.08	0.12	EEEFT1V331AP	EEEFT1V331AV	(6)	500
	390	8.0	10.2	10.5	F	850	0.08	0.12	EEEFT1V391UP	EEEFT1V391UV	(6)	500
	560	10.0	10.2	10.5	G	1190	0.06	0.12	EEEFT1V561AP	EEEFT1V561AV	(6)	500
	680	10.0	10.2	10.5	G	1190	0.06	0.12	EEEFT1V681UP	EEEFT1V681UV	(6)	500
50	10	4.0	5.8	–	(B)	85	2.30	0.10	EEEFTH100UAR	–	(5)	2000
		5.0	5.8	–	C	165	0.88	0.10	EEEFT1H100AR	–	(5)	1000
	22	5.0	5.8	–	C	165	0.88	0.10	EEEFT1H220AR	–	(5)	1000
	47	6.3	5.8	6.1	D	195	0.68	0.10	EEEFT1H470AP	EEEFT1H470AV	(5)	1000
	100	6.3	7.7	8.0	D8	350	0.34	0.10	EEEFTH101XAP	EEEFTH101XAV	(5)	900
	220	8.0	10.2	10.5	F	670	0.18	0.10	EEEFT1H221AP	EEEFT1H221AV	(6)	500
	330	10.0	10.2	10.5	G	900	0.12	0.10	EEEFT1H331AP	EEEFT1H331AV	(6)	500

*1: Size code( ): Miniaturization product
*2: Ripple current (100 kHz / +105 ℃)
*3: ESR (100 kHz / +20 ℃)
*4: tan δ (120 Hz / +20 ℃)
・If Part number exceeds 12 digits, voltage code is abbreviated as follows; 0J → J, 1A → A, 1C → C, 1E → E, 1V → V, 1H → H
・Please refer to the page of "Reflow Profile" and "The Taping Dimensions".

FT series (High temp. reflow)

Characteristics list (Endurance 5000 h)

Endurance : 105 ℃ 5000 h (6.3 V.DC : 105 ℃ 3000 h)

Rated voltage (V)	Capacitance (±20 %) (μF)	Case size (mm)			Size code	Specification			Part No.		Reflow	Min. Packaging Q'ty (pcs)
		φD	L			Ripple current*1 (mA rms)	ESR*2 (Ω)	tan δ*3	Standard Product	Vibration-proof product		Taping
			Standard	Vibration -proof								
6.3	1500	8.0	10.2	10.5	F	850	0.08	0.26	EEEFT0J152GP	EEEFT0J152GV	(6)	500
	2200	10.0	10.2	10.5	G	1190	0.06	0.28	EEEFT0J222GP	EEEFT0J222GV	(6)	500
10	1000	8.0	10.2	10.5	F	850	0.08	0.19	EEEFT1A102GP	EEEFT1A102GV	(6)	500
	1500	10.0	10.2	10.5	G	1190	0.06	0.19	EEEFT1A152GP	EEEFT1A152GV	(6)	500
16	680	8.0	10.2	10.5	F	850	0.08	0.16	EEEFT1C681GP	EEEFT1C681GV	(6)	500
	1000	10.0	10.2	10.5	G	1190	0.06	0.16	EEEFT1C102GP	EEEFT1C102GV	(6)	500
25	470	8.0	10.2	10.5	F	850	0.08	0.14	EEEFT1E471GP	EEEFT1E471GV	(6)	500
	820	10.0	10.2	10.5	G	1190	0.06	0.14	EEEFT1E821GP	EEEFT1E821GV	(6)	500
35	330	8.0	10.2	10.5	F	850	0.08	0.12	EEEFT1V331GP	EEEFT1V331GV	(6)	500
	560	10.0	10.2	10.5	G	1190	0.06	0.12	EEEFT1V561GP	EEEFT1V561GV	(6)	500
50	220	8.0	10.2	10.5	F	670	0.18	0.10	EEEFT1H221GP	EEEFT1H221GV	(6)	500
	330	10.0	10.2	10.5	G	900	0.12	0.10	EEEFT1H331GP	EEEFT1H331GV	(6)	500

*1: Ripple current (100 kHz / +105 ℃)
*2: ESR (100 kHz / +20 ℃)
*3: tan δ (120 Hz / +20 ℃)
・Please refer to the page of "Reflow Profile" and "The Taping Dimensions".

Guidelines and precautions regarding the technical information and use of our products described in this online catalog.

- If you want to use our products described in this online catalog for applications requiring special qualities or reliability, or for applications where the failure or malfunction of the products may directly jeopardize human life or potentially cause personal injury (e.g. aircraft and aerospace equipment, traffic and transportation equipment, combustion equipment, medical equipment, accident prevention, anti-crime equipment, and/or safety equipment), it is necessary to verify whether the specifications of our products fit to such applications. Please ensure that you will ask and check with our inquiry desk as to whether the specifications of our products fit to such applications use before you use our products.

- The quality and performance of our products as described in this online catalog only apply to our products when used in isolation. Therefore, please ensure you evaluate and verify our products under the specific circumstances in which our products are assembled in your own products and in which our products will actually be used.

- If you use our products in equipment that requires a high degree of reliability, regardless of the application, it is recommended that you set up protection circuits and redundancy circuits in order to ensure safety of your equipment.

- The products and product specifications described in this online catalog are subject to change for improvement without prior notice. Therefore, please be sure to request and confirm the latest product specifications which explain the specifications of our products in detail, before you finalize the design of your applications, purchase, or use our products.

- The technical information in this online catalog provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.

- If any of our products, product specifications and/or technical information in this online catalog is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially with regard to security and export control, shall be observed.

<Regarding the Certificate of Compliance with the EU RoHS Directive/REACH Regulations>

- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.

- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

We do not take any responsibility for the use of our products outside the scope of the specifications, descriptions, guidelines and precautions described in this online catalog.

Notices

■ Applicable laws and regulations

・This product complies with the RoHS Directive (Restriction of the use of certain hazardous substances in electrical and electronic equipment (DIRECTIVE 2011/65/EU and (EU)2015/863)).
・ No Ozone Depleting Chemicals(ODC's), controlled under the Montreal Protocol Agreement, are used in producing this product.
We do not use PBBs or PBDEs as brominated flame retardants.
・ Export procedure which followed export related regulations, such as foreign exchange and a foreign trade method, on the occasion of export of this product.
・ These products are not dangerous goods on the transportation as identified by UN(United Nations) numbers or UN classification.

■ Limited applications

・ This capacitor is designed to be used for electronics circuits such as audio/visual equipment, home appliances, computers and other office equipment, optical equipment, measuring equipment.
・ An advanced specification must be signed individually for high-reliability use that might threaten human life or property due to a malfunction of the capacitor.

■ Intellectual property rights and licenses

・ The technical information in this specification provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.

Items to be observed

■ For specification

・ This specification guarantees the quality and performance of the product as individual components.
The durability differs depending on the environment and the conditions of usage.
Before use, check and evaluate their compatibility with actual conditions when installed in the products.
When safety requirements cannot be satisfied in your technical examination, inform us immediately.
・ Do not use the products beyond the specifications described in this document.

■ Upon application to products where safety is regarded as important

Install the following systems for a failsafe design to ensure safety if these products are to be used in equipment where a defect in these products may cause the loss of human life or other signification damage, such as damage to vehicles (automobile, train, vessel), traffic lights, medical equipment, aerospace equipment, electric heating appliances, combustion/ gas equipment, rotating rotating equipment, and disaster/crime prevention equipment.

(1) The system is equipped with a protection circuit and protection device.
(2) The system is equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.

■ Conditions of use

・ Before using the products, carefully check the effects on their quality and performance, and determined whether or not they can be used. These products are designed and manufactured for general-purpose and standard use in general electronic equipment. These products are not intended for use in the following special conditions.

(1) In liquid, such as Water, Oil, Chemicals, or Organic solvent.
(2) In direct sunlight, outdoors, or in dust.
(3) In vapor, such as dew condensation water of resistive element, or water leakage, salty air, or air with a high concentration corrosive gas, such as Cl_2, H_2S, NH_3, SO_2, or NOx.
(4) In an environment where strong static electricity or electromagnetic waves exist.
(5) Mounting or placing heat-generating components or inflammables, such as vinyl-coated wires, near these products.
(6) Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin and other material.
(7) Using resolvent, water or water-soluble cleaner for flux cleaning agent after soldering. (In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues)
(8) Using in the atmosphere where strays acid or alkaline.
(9) Using in the atmosphere where there are excessive vibration and shock.
(10) Using in the atmosphere where there are low pressure or decompression.

・ Please arrange circuit design for preventing impulse or transitional voltage.
Do not apply voltage, which exceeds the full rated voltage when the capacitors receive impulse voltage, instantaneous high voltage, high pulse voltage etc.
・ Our products there is a product are using an electrolyte solution. Therefore, misuse can result in rapid deterioration of characteristics and functions of each product. Electrolyte leakage damages printed circuit and affects performance, characteristics, and functions of customer system.

⚠ Application guidelines（SMD Type）

1. Circuit design

1.1 Operating temperature and frequency

Electrical characteristics of the capacitor are likely to change due to variation in temperature and/or frequency. Circuit designers should take these changes into consideration.

(1) Effects of operating temperature on electrical parameters

At higher temperatures : leakage current and capacitance increase while equivalent series resistance (ESR) decreases.

At lower temperatures : leakage current and capacitance decrease while equivalent series resistance (ESR) increases.

(2) Effects of frequency on electrical parameters

At higher frequencies : capacitance and impedance decrease while tan δ increases.

At lower frequencies : heat generated by ripple current will rise due to an increase in equivalent series resistance (ESR).

1.2 Operating temperature and life expectancy

(1) Expected life is affected by operating temperature. Generally, each 10 °C reduction in temperature will double the expected life. Use capacitors at the lowest possible temperature below the upper category temperature.

(2) If operating temperatures exceed the upper category limit, rapid deterioration of electrical parameter will occur and irreversible damage will result.
Measure not only the ambient temperature but also the surface temperature of the capacitor's case top, which has effects of ripple current and radiated heat from power transistors, IC's, and/or resistors.
Avoid placing components, which could conduct heat to the capacitor from the back side of the circuit board.

(3) The formula for calculating expected life is as follows ;

$$L_2 = L_1 \times 2^{\frac{T_1 - T_2}{10}} \quad \text{where } T_1 \geqq T_2$$

L_1 : Guaranteed life (h) at temperature, T_1 ℃
L_2 : Expected life (h) at temperature, T_2 ℃
T_1 : Upper category temperature (℃)
T_2 : Actual operating temperature, ambient temperature + temperature rise due to ripple current (℃)

(4) Using the capacitor beyond the rated lifetime will result in short circuit, electrolyte leak, vent open, and large deterioration of characteristics. The lifetime cannot exceed 15 years due to aging of sealing rubber.

1.3 Load conditions to avoid

The following load conditions will cause rapid deterioration of capacitor's electrical characteristics.
In addition, instantaneous heating and gas generation within the capacitor may cause an operation of pressure relief vent, and that results in electrolyte leaks, explosion and/or fire ignition.
The leaked electrolyte is combustible and electrically conductive.

(1) Reverse voltage
DC capacitors have polarity. Therefore, do not apply the reverse voltage. Find the correct polarity before insertion.

(2) Charge / Discharge applications
General purpose capacitors are not suitable for use in repeating charge/discharge applications.
For such applications, consult a sales representative with actual application condition. Rush current must not exceed 100 A.

(3) ON-OFF circuit
When using capacitors in circuit where ON-OFF switching is repeated more than 10,000 times a day, consult a sales representative with actual application condition for an appropriate choice of capacitors.

(4) Over voltage
Do not apply a voltage exceeding the rated voltage. The rated surge voltage can be applied only for a short time.
Make sure that a sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(5) Ripple current

Do not apply ripple currents exceeding the rated value.

Make sure that rated ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions. Even if the current is below the rated ripple current, using the capacitor for longer than the rated lifetime will cause ESR increase and internal generation of heat, which may eventually lead to vent open, bulging of case/rubber, electrolyte leak, short circuit, explosion, or ignition in the worst case.

1.4 Connections in series or parallel

(1) Capacitors connected in parallel

Because the impedance of the capacitor and PCB's wiring are very close, various impedance values may cause unbalanced ripple current loads among parallel capacitors. Combine the same part number and wire them carefully to minimize the potential risk of an excessive ripple current concentrating to one capacitor of the smallest impedance.

(2) Capacitors connected in series

Voltage being applied to each capacitor must be smaller than the rated voltage. Unbalanced voltages to the series capacitors may exceed the rated voltage. Voltage-divider resistors considering leakage currents could prevent the over-voltage to the series capacitors. Conductive polymer hybrid aluminum electrolytic capacitors are not allowed to be connected in series.

1.5 Capacitor mounting considerations

(1) For double sided circuit boards, avoid wiring patterns passing between the mounted capacitor and the circuit board. When a radial lead type capacitor is dipped into a solder bath, an excess solder may deposit under the capacitor by capillary action, causing short circuit between anode and cathode terminals. Also, lead holes must be placed with special care for radial lead type capacitors because laminate on capacitor's surface may become damaged during flow process.

(2) The pitch between circuit board holes should match the lead wire pitch of the radial lead type capacitors within the specified tolerances. Unmatched pitch may cause an excessive stress on lead wires during the insertion process and result in short/open circuit, increased leakage current, or electrolyte leak.

(3) Clearance for case mounted pressure relief

Capacitors with case mounted pressure relief require sufficient clearance to allow for proper pressure relief operation. The minimum clearance are dependent on capacitor diameters as follows.

(Ø 10 mm to Ø 16 mm: 2 mm minimum, Ø 18 mm: 3 mm minimum)

(4) Wiring near the pressure relief

Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief. Flammable, high temperature gas that exceeds 100 ℃ may be released which could dissolve the wire insulation and ignite.

(5) Circuit board patterns under the capacitor

Avoid circuit board runs under the capacitor, as an electrical short can occur due to an electrolyte leakage.

(6) Resonant vibration after circuit board's production may make a heavy load on the capacitor and cause rapid change in characteristics and/or capacitor's break.

1.6 Electrical isolation

Electrically isolate the capacitor's case from cathode terminals, as well as circuit patterns.

1.7 Capacitor coating

The laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor.

2. Capacitor handling techniques

2.1 Considerations before using

(1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.

(2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption.

If required, this voltage can be discharged with a resistor with a value of about 1 kΩ.

(3) Capacitors stored for a long period of time may exhibit an increase in leakage current.

This can be corrected by gradually applying rated voltage in series with a resistor of approximately 1 kΩ.

(4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.

(5) Dented or crushed capacitors should not be used.

The seal integrity can be damaged and loss of electrolyte/ shortened life can result.

2.2 Capacitor insertion

(1) Verify the correct capacitance and rated voltage of the capacitor.
(2) Verify the correct polarity of the capacitor before insertion.
(3) Verify the correct terminal dimension and land pattern size for surface mount type, or holes' pitch for radial lead type before mount to avoid short circuit, stress on the terminals, and/or lack of terminal strength.
(4) Excessive mounting pressure can cause high leakage current, short circuit, or disconnection.
(5) When using a mounter for radial lead type, avoid cutter wear and acute angle of lead-bending with respect to circuit board. That may create excessive stress and pull the lead to damage the capacitor.

2.3 Reflow soldering (for surface mount type)

(1) Surface-mount type capacitor are exclusively for reflow soldering.
When reflow solder is used an ambient heat condition system such as the simultaneous use of infrared and hot-air is recommended.
(2) Observe proper soldering conditions (temperature, time, etc.). Do not exceed the specified limits.
If the peak temperature is high or if the heating time is long, it may cause deterioration of the electrical characteristics and life characteristics.
Recommended soldering condition is a guideline for ensuring the basic characteristics of the components, but not for the stable soldering conditions. Conditions for proper soldering should be set up according to individual onditions.
・The Temperature on Capacitor top shall be measured by using thermal couple that is fixed firmly by epoxy glue.
(3) In case of use in 2 times reflow, 2nd reflow must be done when the capacitor's temperature return back to normal level.
(4) In our recommended reflow condition , the case discoloration and the case swelling might be slightly generated. But please acknowledge that these two phenomena do not influence the reliability of the product.
(5) The crack on top marking might be occurred by reflow heat stress.
But please acknowledge that it does not influence the reliability of the product.
(6) VPS (Vapor Phase Soldering) reflow can cause significant characteristics change and/ or mounting failure due to deformation by acute temperature rise.
VPS is acceptable provided that the process does not exceed recommended reflow profile and temperature rise is less than 3 ℃/sec.
Please contact Panasonic for detailed conditions.
(7) The vibration-proof capacitors of size ø6.3 has support terminals extending from the bottom side to the lead edge. Then, make sure to find appropriate soldering conditions to form fillet on the support terminals if required for appearance inspection. However, even if sufficient solder fillets are not observed, the reliability of vibration-proof will not be lowered because the support terminals on the bottom side enhance the solder joint to PCB.

2.4 Flow soldering (for radial lead type)

(1) Radial lead type capacitors cannot apply to reflow soldering.
(2) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
(3) Apply proper soldering conditions (temperature, time, etc.). Do not exceed the specified limits.
(4) Do not allow other parts or components to touch the capacitor during soldering.

2.5 Manual soldering

(1) Apply soldering conditions (temperature and time) based on the specification, or do not exceed temperature of 350 ℃ for 3 seconds.
(2) If a soldered capacitor must be removed and reinserted, avoid excessive stress on the capacitor leads.
(3) Avoid physical contacts between the tip of the soldering iron and capacitors to prevent or capacitor failure.
(4) When bending lead wires of radial type capacitors to match the hole pitch on PCB, avoid applying excessive stress to the capacitor body.

2.6 Capacitor handling after soldering

(1) Avoid moving the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal. The capacitor may break from element portion due to a torque at outer rim, causing a large stress to terminals.
(2) Do not use the capacitor as a handle when moving the circuit board assembly. The total weight of the board would apply to element portion through terminals, and the capacitor may break.
(3) Avoid striking the capacitor after assembly to prevent failure due to excessive shock. The capacitor may break due to excessive shock or load above specified range.

2.7 Circuit board cleaning

(1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up to 5 minutes and up to 60 °C maximum temperatures. The boards should be thoroughly rinsed and dried. The use of ozone depleting cleaning agents is not recommended for the purpose of protecting our environment.

【Target solvent】

Pine Alpha ST-100S, Aqua Cleaner 210SEP, Clean-thru 750H / 750L / 710M, Sunelec B-12, Sunelec B-12, Cold Cleaner P3-375, Techno Cleaner 219, DK Be-clear CW-5790, Telpene Cleaner EC-7R, Technocare FRW-17 / FRW-1 / FRV-1

(2) Avoid using the following solvent groups unless specifically allowed in the specification ;

(a) Halogenated based solvents : may permeate the seal and cause internal corrosion. Especially, 1-1-1 trichloroethane must not be used on any aluminum electrolytic capacitors.

(b) Alkaline based solvents : may dissolve and react to the aluminum case.

(c) Petroleum based solvents : may deteriorate the sealing rubber.

(d) Xylene : may deteriorate the sealing rubber.

(e) Acetone : may erase the markings on the capacitor top.

(3) A thorough drying after cleaning is required to remove residual cleaning solvents that may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the upper category temperature of the capacitor.

(4) Monitor the contamination levels of the cleaning solvents during use in terms of electrical conductivity, pH, specific gravity, and water content. Inside the capacitor may corrode with high density of chlorine. Control the flux density in the cleaning agent to be less than 2 mass%.

(5) Depending on the cleaning method, the marking on a capacitor may be erased or blurred.

※ Please consult us if you are not certain about acceptable cleaning solvents or cleaning methods.

2.8 Mounting adhesives and coating agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

Cure or dry out the coating agents thoroughly, and do not leave any solvents. Make sure to dry out cleaning agents completely immediately after washing the circuit board if the capacitors are mounted afterward, so that the solvents are not left under the capacitor body. Also, leave more than 1/3 of the sealing portion open, and do not cover that portion with any adhesives or coating.

2.9 Potting and molding

Potting and molding processes cannot be recommended. They have potential risks to change the capacitor's performance and reliability due to injection pressure, diffused material into the capacitor, as well as heat accumulation by covered resin. Also, evaporated electrolyte may remain inside the resin, then turn to liquid, and possibly short circuit PCB patterns.

2.10 Fumigation

In exporting electronic appliances with aluminum electrolytic capacitors, in some cases fumigation treatment using such halogen compound as methyl bromide is conducted for wooden boxes.

If such boxes are not dried well, the halogen left in the box is dispersed while transported and enters in the capacitors inside. This possibly causes electrical corrosion of the capacitors. Therefore, after performing fumigation and drying make sure that no halogen is left. Don't perform fumigation treatment to the whole electronic appliances packed in a box.

2.11 Flux

If you use a halogen type (Chlorine type, Bromine type, etc.) high-activity flux, please use it after confirmation in advance, as it may have an impact on performance and reliability of this product due to the residue of the flux.

3. Precautions for using capacitors

3.1 Environmental conditions

Capacitors should not be stored or used in the following environments.

(1) Exposure to temperatures above the upper category or below the lower category temperature of the capacitor.

(2) Direct contact with water, salt water, or oil.

(3) High humidity conditions where water could condense on the capacitor.

(4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, chlorine compound, bromine, bromine compound or ammonia.

(5) Exposure to ozone, radiation, or ultraviolet rays.

(6) Vibration and shock conditions exceeding specified requirements.

Even within the specified requirements, a large vibration acceleration may be applied due to resonance, so be sure to evaluate and confirm with the actual product.

3.2 Electrical precautions

(1) Avoid touching the terminals of a capacitor as a possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
(2) Avoid short circuiting the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.
(3) A low-molecular-weight-shiroxane which is included in a silicon material shall causes abnormal electrical characteristics.

4. Emergency procedures

(1) If the pressure relief of the capacitor operates, immediately turn off the equipment and disconnect from the power source.
This will minimize an additional damage caused by the vaporizing electrolyte.
(2) Avoid contact with the escaping electrolyte gas, which can exceed 100 ℃ temperatures.
If electrolyte or gas enters the eye, immediately flush the eye with large amounts of water.
If electrolyte or gas is ingested by mouth, gargle with water.
If electrolyte contacts the skin, wash with soap and water.

5. Long term storage

(1) Leakage current of a capacitor tends to increase after a long-term storage due to dielectric dissolution, and very high current may flow at the first voltage load. However, applying voltage will form the dielectric, and the leakage current will decrease. Expiration date is 42 months from the outgoing inspection date for part numbers listed below, and it is 12 month for part numbers not listed below.

Series	Expiration date
S (Only high temperature reflow) HA (Only high temperature reflow) HB (Only high temperature reflow and 5.4 mm height) HC, HD, FCA, FC, FKA, FK, FKS, FN, FP, FT, FH, TG, TK,TP, TC, TCU, TQ	42 months from outgoing inspection date

Storage condition is to keep in room temperature (5 ℃ to 35 ℃) and humidity (45 % to 85 %) with no direct sunshine.

(2) Environmental conditions
Do not store under condition outside the area described in the specification, and also under conditions listed below.
(a) Exposure to temperatures above the upper category or below the lower category temperature of the capacitor.
(b) Direct contact with water, salt water, or oil.
(c) High humidity conditions where water could condense on the capacitor.
(d) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, Chlorine compound, Bromine, Bromine compound or ammonia.
(e) Exposure to ozone, radiation, or ultraviolet rays.
(f) Vibration and shock conditions exceeding specified requirements.

6. Capacitor disposal

When disposing capacitors, use one of the following methods.
(1) Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise).
(2) Dispose as solid waste.

NOTE : Local laws may have specific disposal requirements which must be followed.

The precautions in using aluminum electrolytic capacitors follow the "Safety application guide for the use in fixedaluminum electrolytic capacitors for electronic equipment", RCR-2367D issued by JEITA in October 2017.
Please refer to the above application guide for details.

■ AEC-Q200 compliant

The products are tested based on all or part of the test conditions and methods defined in AEC-Q200.
Please consult with Panasonic for the details of the product specification and specific evaluation test results, etc., and please review and approve Panasonic's product specification before ordering.